

CC5V-T1A

Product Documentation

CC5V-T1A

Quartz Crystal Unit 32.768 kHz

2. Product Description

The CC5V-T1A is a low frequency SMT Quartz Crystal Unit that incorporates a tuning fork Quartz Crystal Resonator. The Quartz Crystal Resonator operates under vacuum condition in a hermetically sealed ceramic package with ceramic lid.

Suitable oscillator-circuitries can operate the CC5V-T1A Quartz Crystal Units in fundamental mode consuming very low power. For technical assistance for optimizing oscillator-circuitries please contact Micro Crystal under <u>sales@microcrystal.com</u>

CC5V-T1A is compatible with other suppliers' same footprint crystals.

2.1. Application Examples

Metering Industrial Automotive Health Care Medical Implantable Harsh Environments

2.2. Ordering Information

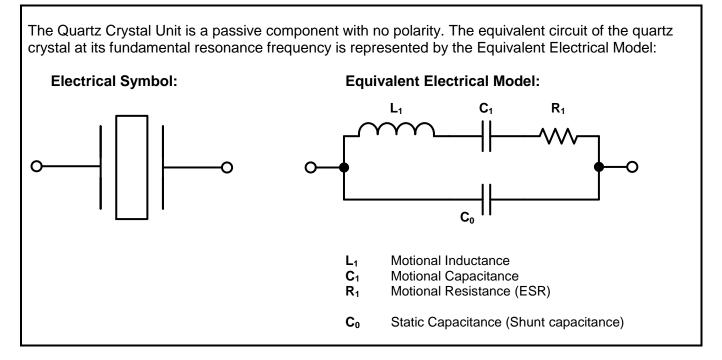
Example: CC5V-T1A 32.768 kHz CL: 12.5 pF -20/+20ppm TA QC

Code	Operating temperature range
TA (Standard)	-40 to +85°C
ТВ	-40 to +125°C
TC	-55 to +125°C

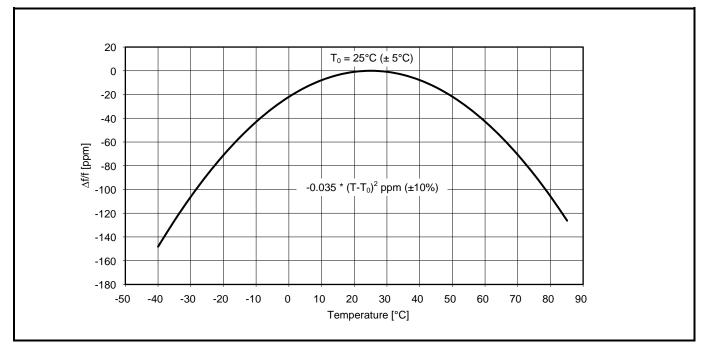
Code	Qualification
QC (Standard)	Commercial Grade
QM	Medical Grade

3. Electrical Characteristics

3.1. Equivalent Electrical Model

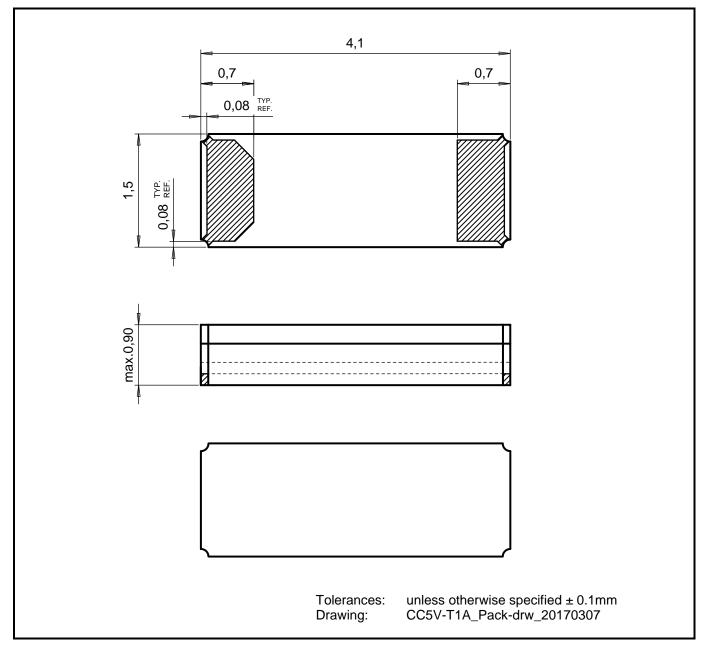


3.2. Frequency vs Temperature Characteristics

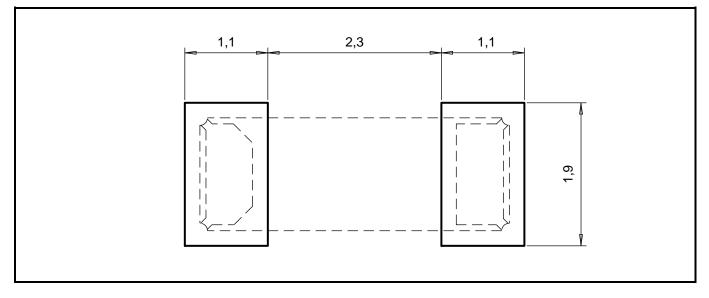


4. Mechanical Properties

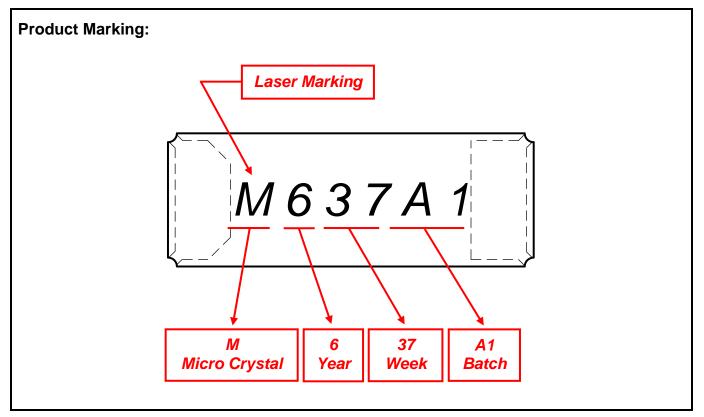
4.1. Package Dimension



4.2. Recommended Solderpad Layout



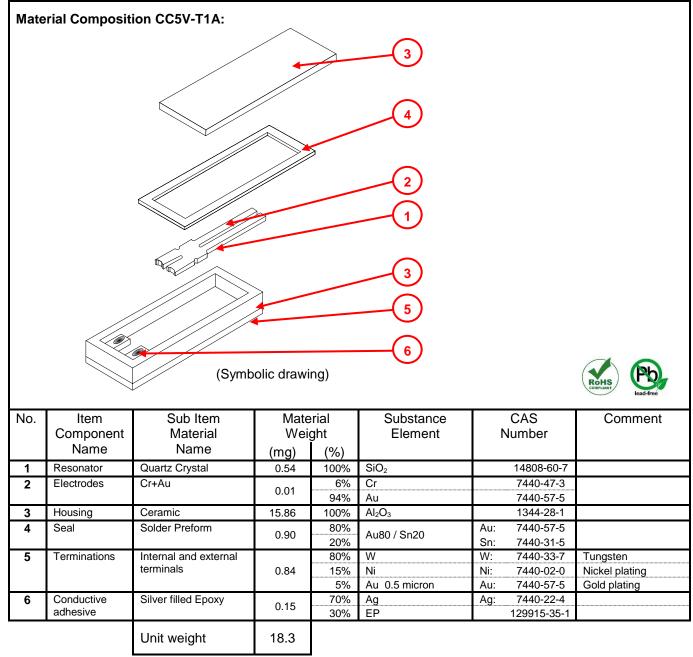
4.3. Product Marking



5. Material Composition Declaration & Environmental Information

5.1. Homogenous Material Composition Declaration

Homogenous material information according to IPC-1752 standard



5.2. Material Analysis & Test Results

Homogenous material information according to IPC-1752 standard

No.	No. Item Sub Item Component Material		RoHS						Halogen			Phthalates				
	Name	Name	qd	Сd	бH	Cr+6	PBB	PBDE	Ъ	CI	Br	I	98P	dBP	DEHP	DINP
1	Resonator	Quartz Crystal	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
2	Electrodes	Cr+Au	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
3	Housing	Ceramic	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
4	Seal	Solder Preform	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
5	Terminations	Int. & ext. terminals	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
6	Conductive adhesive	Silver filled Epoxy	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd	nd
	MDL	Measurement Detection Limit		2 p	pm		5 pp	m		50 p	opm		0.00	3%		0.01%

Test methods:

RoHS Te Halogen Te Phthalates Te

Test method with reference to IEC 62321-5: 2013 Test method with reference to BS EN 14582:2007 Test method with reference to EN 14372 nd = not detectable

MDL: 2 ppm (PBB / PBDE: 5 ppm)

MDL: 50 ppm

MDL: 0.003 % (DINP 0.01%)

5.3. Recycling Material Information

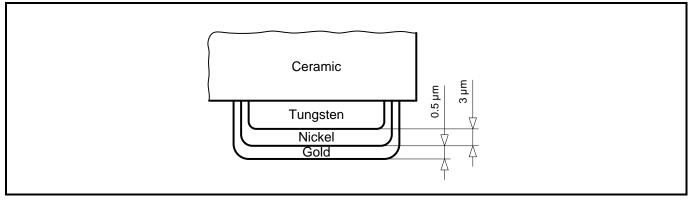
Recycling material information according to IPC-1752 standard.

ltem	No.	Item	Material		Substance	CAS	Comment	
Material		Component	Weight		Element	Number		
Name		Name	(mg)	(%)				
Quartz Crystal	1	Resonator	0.54	2.95	SiO ₂	14808-60-7		
Chromium	2	Electrodes	0.0006	0.0033	Cr	7440-47-3		
Ceramic	3	Housing	15.86	86.67	AI_2O_3	1344-28-1		
Gold	2 4 5	Electrodes Seal Terminations	0.77	4.22	Au	7440-57-5		
Tin	4	Seal	0.18	0.98	Sn	Sn: 7440-31-5		
Nickel	5	Terminations	0.13	0.69	Ni	Ni: 7440-02-0		
Tungsten	5	Terminations	0.67	3.67	W	W: 7440-33-7		
Silver	6a	Conductive adhesive	0.105	0.57	Ag	Ag: 7440-22-4		
Ероху	6b	Conductive adhesive	0.045	0.25	EP	129915-35-1		
	Unit	weight (total)	18.3	100				

5.4. Environmental Properties & Absolute Maximum Ratings

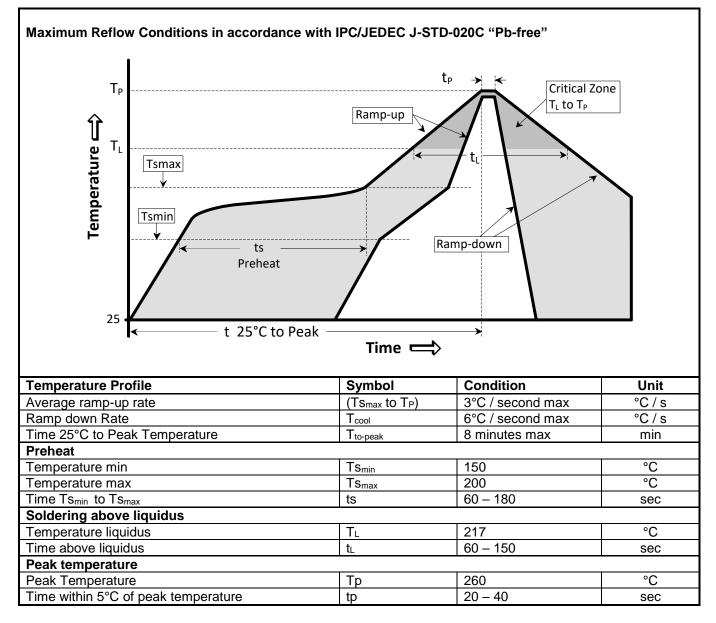
Package	Description						
Ceramic Package	Hermetic ceramic-package, no-leads						
Parameter	Directive	Conditions	Value				
Product weight (total)			18.3 mg				
Storage temperature		Store as bare product	-55 to +125°C				
Moisture sensitivity level (MSL)	IPC/JEDEC J-STD-020D		MSL 1				
FIT / MTBF			available on request				

Terminal finish:



6. Application Information

6.1. Soldering Information



6.2. Handling Instructions for Quartz Crystal Units

The built-in tuning-fork crystal consists of pure Silicon Dioxide in crystalline form. The cavity inside the package is evacuated and hermetically sealed in order for the crystal blank to function undisturbed from air molecules, humidity and other influences.

Shock and vibration:

Keep the crystal / module from being exposed to **excessive mechanical shock and vibration**. Micro Crystal guarantees that the crystal / module will bear a mechanical shock of 5000 g / 0.3 ms.

The following special situations may generate either shock or vibration:

Multiple PCB panels - Usually at the end of the pick & place process the single PCBs are cut out with a router. These machines sometimes generate vibrations on the PCB that have a fundamental or harmonic frequency close to 32.768 kHz. This might cause breakage of crystal blanks due to resonance. Router speed should be adjusted to avoid resonant vibration.

Ultrasonic cleaning - Avoid cleaning processes using ultrasonic energy. These processes can damage crystals due to mechanical resonance of the crystal blank.

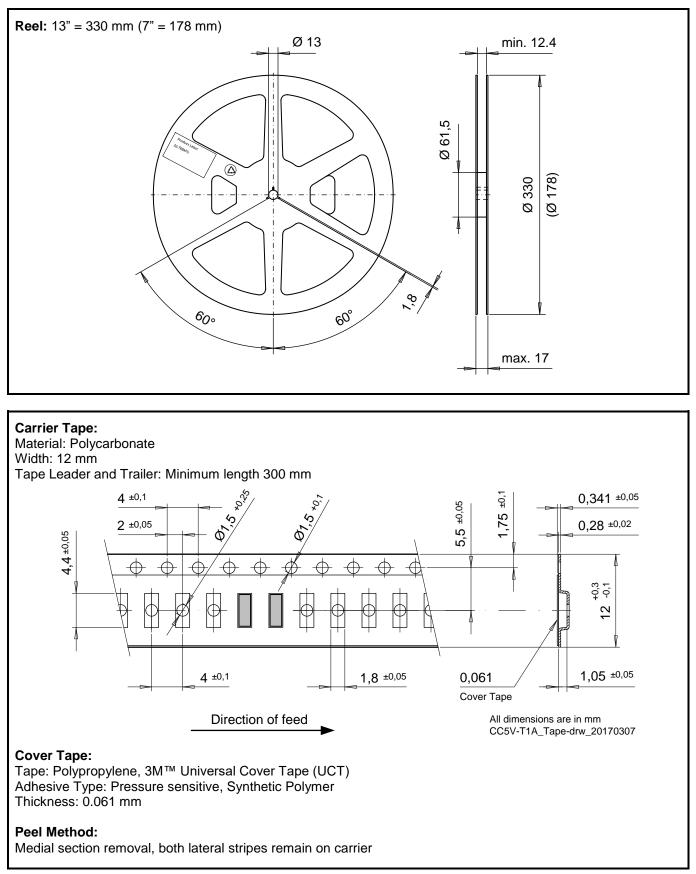
Overheating, rework high temperature exposure:

Avoid overheating the package. The package is sealed with a seal ring consisting of 80% Gold and 20% Tin. The eutectic melting temperature of this alloy is at 280°C. Heating the seal ring up to >280°C will cause melting of the metal seal which then, due to the vacuum, is sucked into the cavity forming an air duct. This happens when using hot-air-gun set at temperatures >300°C.

Use the following methods for rework:

- Use a hot-air- gun set at 270°C.
- Use 2 temperature controlled soldering irons, set at 270°C, with special-tips to contact all solder-joints from both sides of the package at the same time, remove part with tweezers when pad solder is liquid.

7. Packing & Shipping Information



8. Compliance Information

Micro Crystal confirms that the standard product Quartz Crystal Unit CC5V-T1A is compliant with "EU RoHS Directive" and "EU REACh Directives".

Please find the actual Certificate of Conformance for Environmental Regulations on our website: CoC Environment CC&CM-Series.pdf

9. Document Revision History

Date	Revision #	Revision Details
March 2017	1.0	First release
September 2020	1.1	Added that CC5V-T1A is compatible with other suppliers' same footprint crystals, 2.

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